

Alternatives to BPA in Thermal Paper Partnership

Report Outline



Purpose of Presentation



- Explain elements of DfE Alternatives Assessment Report
- Focus attention on information and data needs
- Enhance productivity of subsequent discussions



1.0 Introduction

- 1.1 Purpose of the BPA Alternatives Assessment
- 1.2 Scope of the BPA Alternatives Assessment



2.0 BPA in Thermal Paper

- 2.1 Thermal Print Machinery
- 2.2 Chemistry of Thermal Paper
- 2.3 Applications



3.0 Exposure to BPA in Thermal Paper

- 3.1 Exposure Pathways and Routes (General)
- 3.2 Industrial Releases and Exposures
- 3.3 Worker Exposures
- 3.4 Consumer and General Population Exposures



4.0 BPA Alternatives Evaluations

4.1 Summary of Alternatives

4.2 Chemical Summary Assessments

Flame Retardants in Printed Circuit Boards



		Human Health Hazard Concern								Ecotoxicity Hazard Concern				n	Environmental Concern
		Human Health Effects									Aquatic Toxicity		Environ- mental		Exposure Considerations
Chemical	CASRN	Acute Toxicity	Skin Sensitizer	Cancer Hazard	Immunotoxicity	Reproductive	Developmental	Neurological	Systemic	Genotoxicity	Acute	Chronic	Persistence	Bioaccumulation	Availability of flame retardants (FRs) throughout the lifecycle for reactive and additive FRs chemicals and resins
Reactive Flame Retardant Chemica	ls²														
	Tetrabromobisphenol A (TBBPA) (Albemarle, Chemtura, and others)														Manufacture End-of-Life of Of FR
TBBPA	79-94-7	L	L	L	L	L	M	L	L	L	H	Η	M	L	Electronics Manufacture
DOPO (6H-Dibenz[c,e][1,2] oxapho		de) (S	amko	Co., I	td. aı	id oth	ers)								(Recycle, of FR Resin
DOPO	35948-25-5	L	L	L	L	L	L	L	L	L	M	M	L	L	of Electronics Manufacture
	Fyrolflex PMP (Aryl alkylphosphonate) (Supresta)														of Laminate Manufacture of PCB
Fyrolflex PMP	Proprietary	L	L	L	L	L	L	L	L	L	L	L	H	L	and incorporation into
Reactive Flame Retardant Resins ² Reaction product of TBBPA - D.E.J	eaction product of TBBPA - D.E.R. 538 (Phenol, 4,4'-(1-methylethylidene)bis[2,6-dibromo-, polymer with														Manufacture of
(chloromethyl)oxirane and 4,4'-(1-1		ne)bis	[pheno	ol]) (D	ow C	hemic	al)								End-of-Life of FR Electronics Manufacture
D.E.R. 538	26265-08-7	L	M	M^{\Diamond}	L	M^{\Diamond}	M^{\Diamond}	L	L	M	L	L	M	L	(Recycle, Of FR Resin
Reaction Product of DOPO - Dow 2	XZ-92547 (read	tion p	roduc	t of a	n epo	xy phe	nyl no	ovolak	with	DOPO)	(Don	Cher	mical)		Sale and Use of Electronics Manufacture
Dow XZ-92547	Proprietary	L	M	M^{\Diamond}	L	M^{\Diamond}	M^{\Diamond}	L	L	M^{\diamond}	L	L	H	L	of Laminate
Reaction product of Fyrolflex PMP	with bispheno	l A, p	olyme	r with	epicl	iloroh	ydrin	(Repr	esenta	ative Re	esin)				Manufacture of PCB and Incorporation into
Representative Fyrolflex PCB Resin	Unknown	L	L	M^{\Diamond}	L	M^{\Diamond}	M^{\Diamond}	L	L	M^{\Diamond}	L	L	Н	L	Electronics

5.0 Considerations for Selecting a Replacement for BPA



- 5.1 Positive Attributes
- 5.2 Performance
- 5.3 Process and Equipment Considerations
- 5.4 Economic Viability
- 5.5 Alternative Technologies
- 5.6 Methods for Selecting BPA Alternatives



6.0 Recommendations

7.0 References